

MSQ30C03D

N & P-Channel 30-V (D-S) MOSFET

Description

The device is the highest performance trench N-ch and P-ch MOSFETs with extreme high cell density, which provide excellent $R_{DS(ON)}$ and gate charge for most of the synchronous buck converter applications.

The device meets the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Suit for 4.5V Gate Drive Applications
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

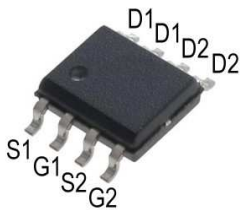
Typical Applications

- DC Fan
- Motor Drive Applications
- Networking
- Half / Full Bridge Topology

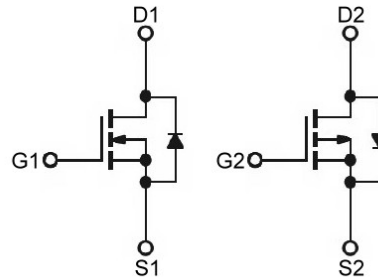
Package type : SOP-8

Packing & Order Information

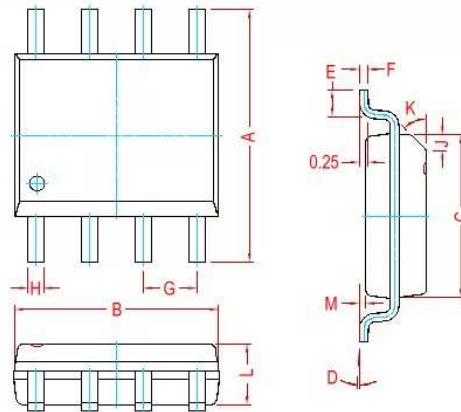
3,000/Reel



Graphic Symbol

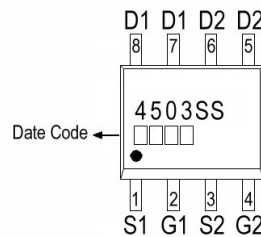


Package Dimension



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	5.80	6.20	M	0.10	0.25
B	4.80	5.00	H	0.35	0.51
C	3.80	4.00	L	1.35	1.75
D	0°	8°	J	0.40 Ref.	
E	0.40	0.90	K	45° Ref.	
F	0.19	0.26	G	1.27 Typ.	

Marking



RoHS Compliant

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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (unless otherwise specified)

Symbol	Parameter	Value		Units
		N-ch	P-ch	
V_{DS}	Drain-Source Voltage	30	-30	V
V_{GS}	Gate-Source Voltage	± 20	± 20	V
I_D	Continuous Drain Current ¹ ($T_A=25^\circ\text{C}$)	6.9	-6.3	A
	Continuous Drain Current ¹ ($T_A=70^\circ\text{C}$)	5.5	-5.0	A
I_{DM}	Pulsed Drain Current ² ($T_A=25^\circ\text{C}$)	20	-18	A
I_{AS}	Single Pulse Avalanche Current, $L=0.1\text{mH}^3$	21	-30	A
E_{AS}	Single Pulse Avalanche Energy, $L=0.1\text{mH}^3$	22	45	mJ
P_D	Power Dissipation ³ ($T_A=25^\circ\text{C}$)	1.5		W
T_J/T_{STG}	Operating Junction and Storage Temperature	-55 to +150		$^\circ\text{C}$

Thermal Resistance Ratings

Symbol	Parameter	Maximum	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient ¹	83	$^\circ\text{C/W}$
$R_{\theta JC}$	Maximum Junction-to-Case ¹	40	$^\circ\text{C/W}$

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Ch	Min.	Typ.	Max.	Units
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$ $V_{DS}=V_{GS}$, $I_D=-250\mu\text{A}$	N	1.2	-	2.5	V
			P	-1.2	-	-2.5	V
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$ $V_{GS}=0\text{V}$, $I_D=-250\mu\text{A}$	N	30	-	-	V
			P	-30	-	-	V
g_{fs}	Forward Transconductance	$V_{DS}=5\text{V}$, $I_D=7\text{A}$ $V_{DS}=-10\text{V}$, $I_D=-12\text{A}$	N	-	6	-	S
			P	-	13	-	S
I_{GSS}	Gate-Source Leakage Current	$V_{DS}=0\text{V}$, $V_{GS}=\pm 20\text{V}$	N P	-	-	± 100	nA
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=24\text{V}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$ $V_{DS}=24\text{V}$, $V_{GS}=0\text{V}$, $T_J=55^\circ\text{C}$ $V_{DS}=-24\text{V}$, $V_{GS}=0\text{V}$, $T_J=55^\circ\text{C}$ $V_{DS}=-24\text{V}$, $V_{GS}=0\text{V}$, $T_J=55^\circ\text{C}$	N	-	-	1	μA
			N	-	-	5	
			P	-	-	-1	
			P	-	-	-5	
$R_{DS(on)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10\text{V}$, $I_D=6\text{A}$ $V_{GS}=4.5\text{V}$, $I_D=4\text{A}$ $V_{GS}=-10\text{V}$, $I_D=-6\text{A}$ $V_{GS}=-4.5\text{V}$, $I_D=-4\text{A}$	N	-	-	28	m Ω
			N	-	-	42	
			P	-	-	36	
			P	-	-	55	
EAS	Single Pulse Avalanche Energy ⁵	$V_{DD}=25\text{V}$, $L=0.1\text{mH}$, $I_{AS}=10\text{A}$ $V_{DD}=-25\text{V}$, $L=0.1\text{mH}$, $I_{AS}=-10\text{A}$	N	5	-	-	mJ
			P	5	-	-	
V_{SD}	Diode Forward Voltage ²	$I_S=6\text{A}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$ $I_S=-6\text{A}$, $V_{GS}=0\text{V}$, $T_J=25^\circ\text{C}$	N	-	-	1.2	V
			P	-	-	-1.2	
I_S	Continuous Source Current ¹⁴ (Diode)	$V_G=V_D=0\text{V}$, Force Current	N	-	-	6.9	A
			P	-	-	-6.3	

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Dynamic and switching Characteristics

Symbol	Parameter	Test Conditions	Ch	Min.	Typ.	Max.	Units
Q _g	Total Gate Charge ²	N-Ch	N	--	6.0	--	nC
			P	--	9.8	--	
Q _{gs}	Gate-Source Charge	V _{DS} =15V, I _D =7A, V _{GS} =4.5V P-Ch	N	--	2.5	--	
			P	--	2.2	--	
Q _{gd}	Gate-Drain Charge	V _{DS} =-20V, I _D =-12A, V _{GS} =-4.5V	N	--	2.1	--	
			P	--	3.4	--	
t _{d(on)}	Turn-On Delay Time ²	N-Ch	N	--	2.4	--	ns
t _r	Rise Time	V _{DS} =15V, I _D =7A, V _{GS} =10V, R _G =3.3Ω	P	--	16.4	--	
			N	--	7.8	--	
t _{d(off)}	Turn-Off Delay Time	P-Ch V _{DS} =-24V, I _D =-1A, V _{GS} =-10V	P	--	20.2	--	
			N	--	22	--	
t _f	Fall Time	R _G =3.3Ω	N	--	4	--	
C _{ISS}	Input Capacitance	N-Ch	N	--	572	--	pF
			P	--	930	--	
C _{OSS}	Output Capacitance	V _{DS} =15V, V _{GS} =0V, f=1.0MHz P-Ch	N	--	80	--	
			P	--	148	--	
C _{RSS}	Reverse Transfer Capacitance	V _{DS} =-15V, V _{GS} =0V, f=1.0MHz	N	--	65	--	
			P	--	115	--	

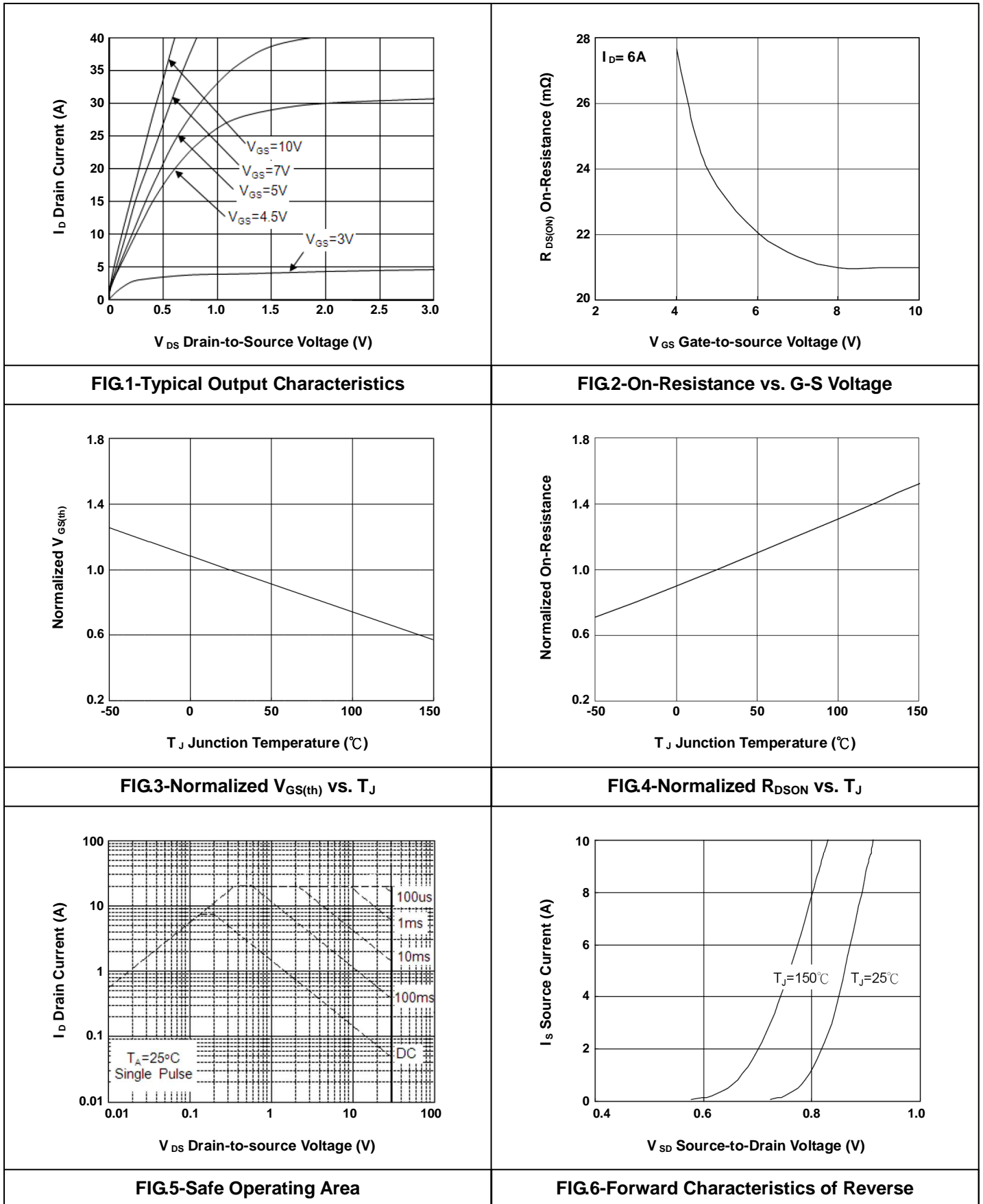
Notes

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. The EAS data shows maximum rating. The test condition is N-ch V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=21A, P-ch V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-30A.
4. The power dissipation is limited by 150°C junction temperature.
5. The Min. value is 100% EAS tested guarantee.
6. The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.

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- Typical Electrical Characteristics N-Channel



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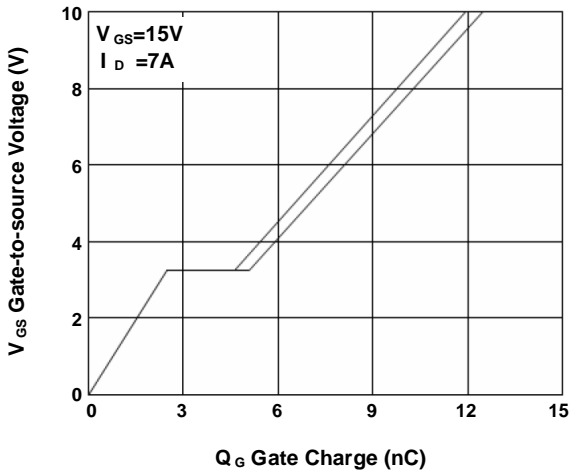


FIG.7-Gate Charge Characteristics

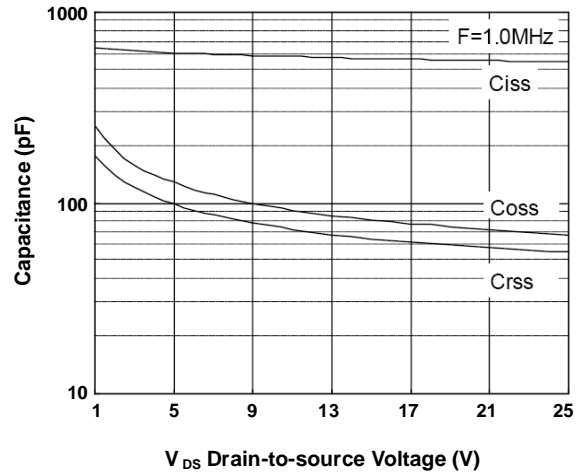


FIG.8-Capacitance Characteristics

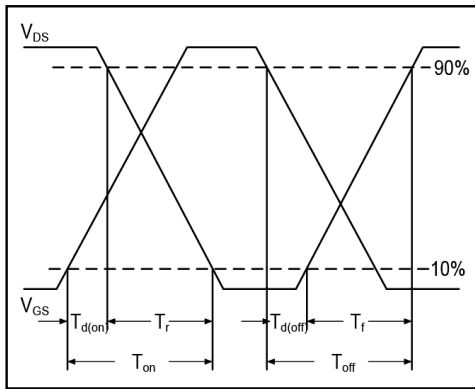


FIG.9-Switching Time Waveform

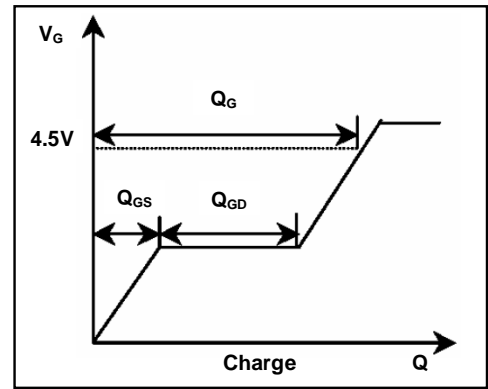


FIG.10-Gate Charge Waveform

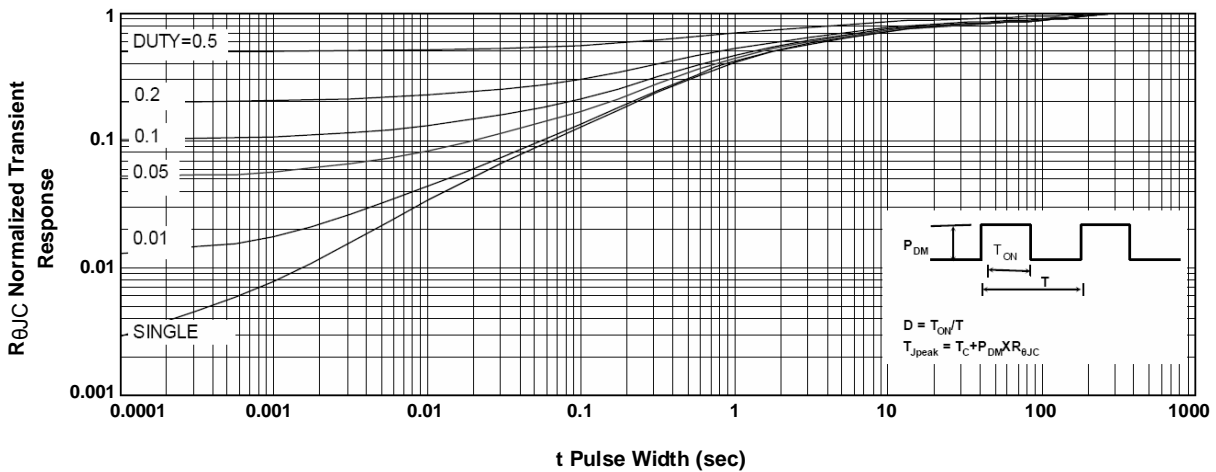
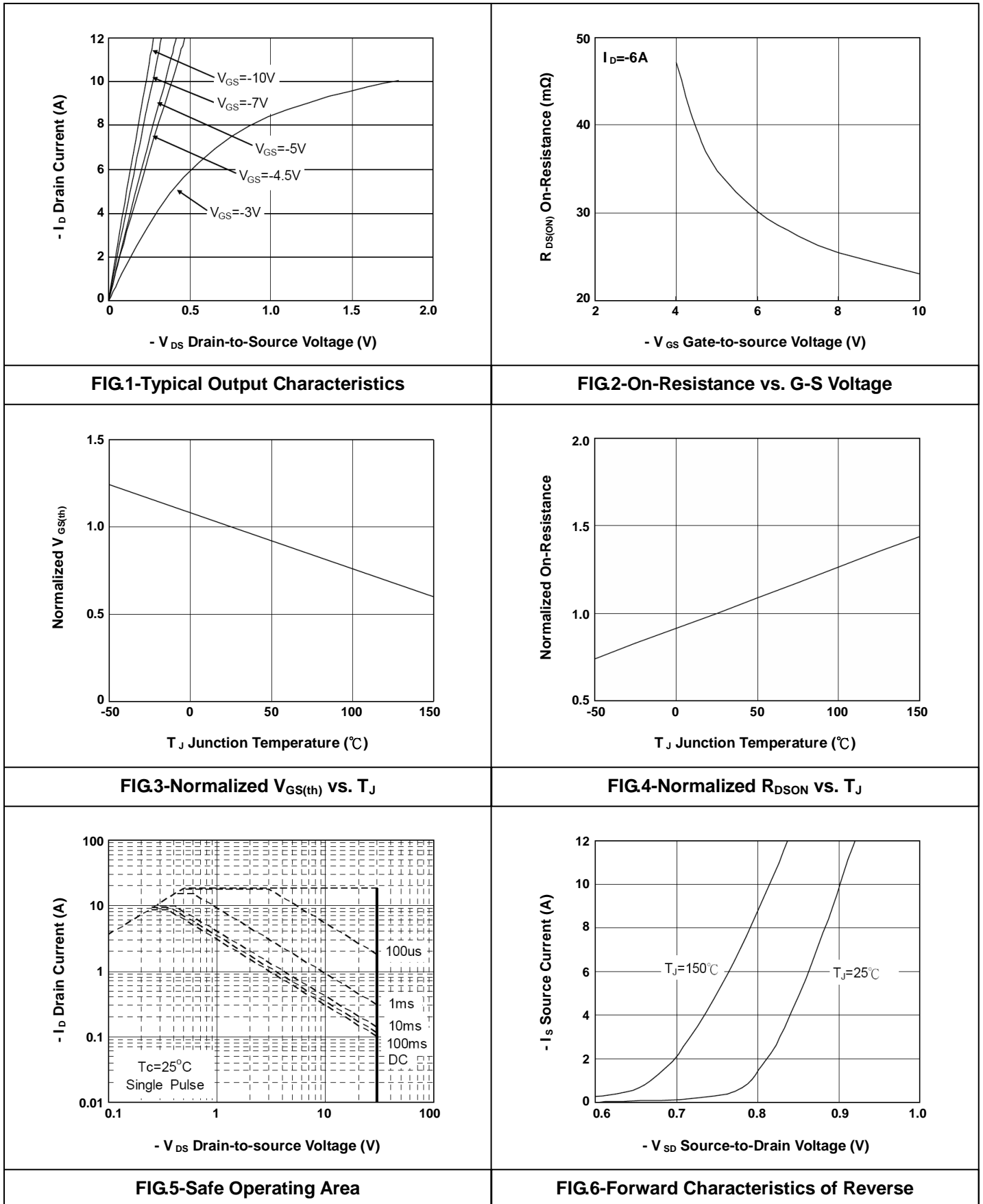


FIG.11-Normalized Maximum Transient Thermal Impedance

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- Typical Electrical Characteristics P-Channel



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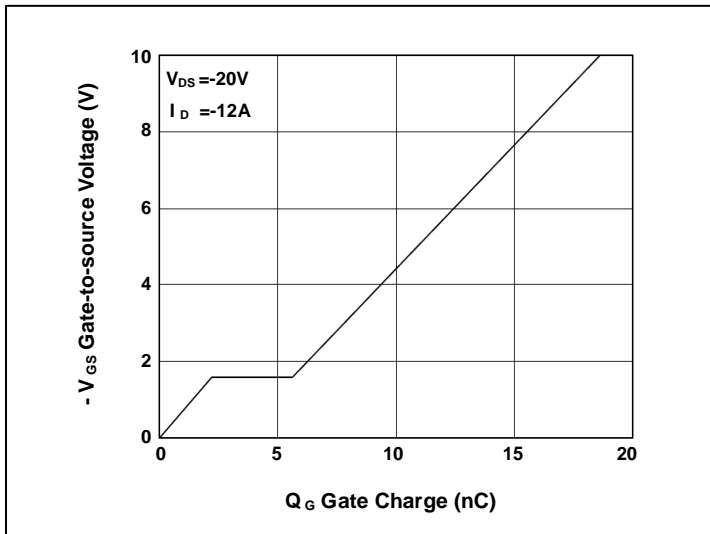


FIG.7-Gate Charge Characteristics

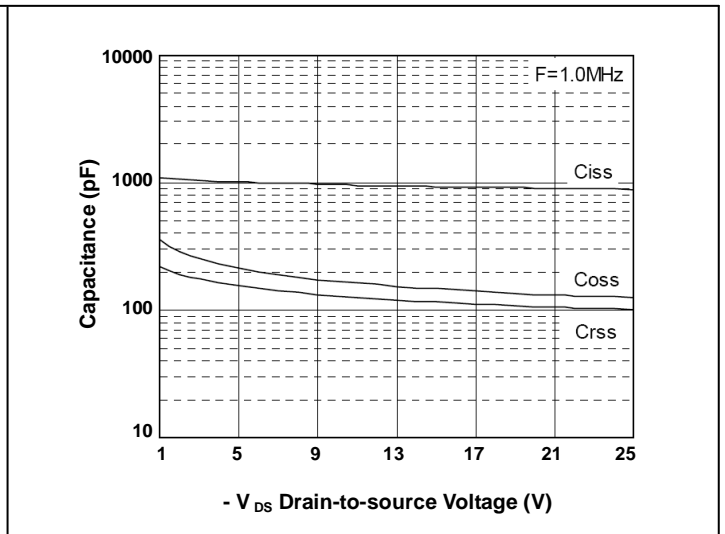


FIG.8-Capacitance Characteristics

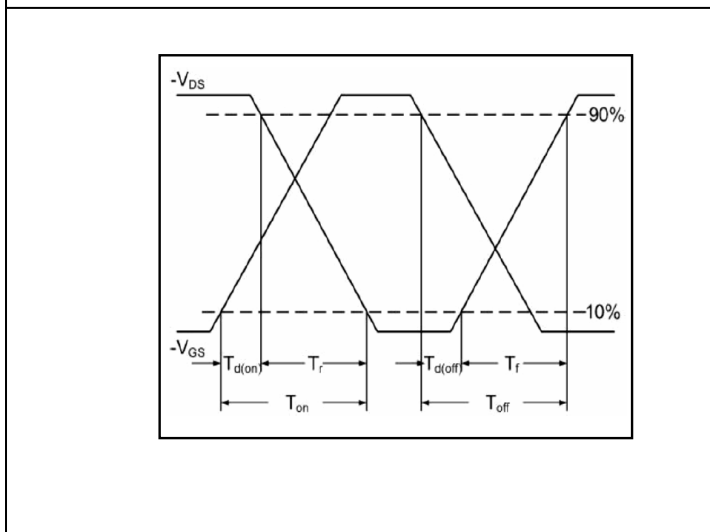


FIG.9-Switching Time Waveform

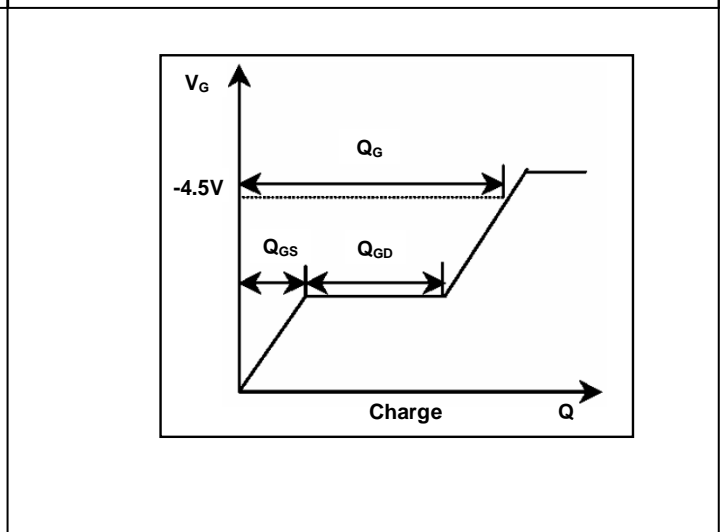


FIG.10-Gate Charge Waveform

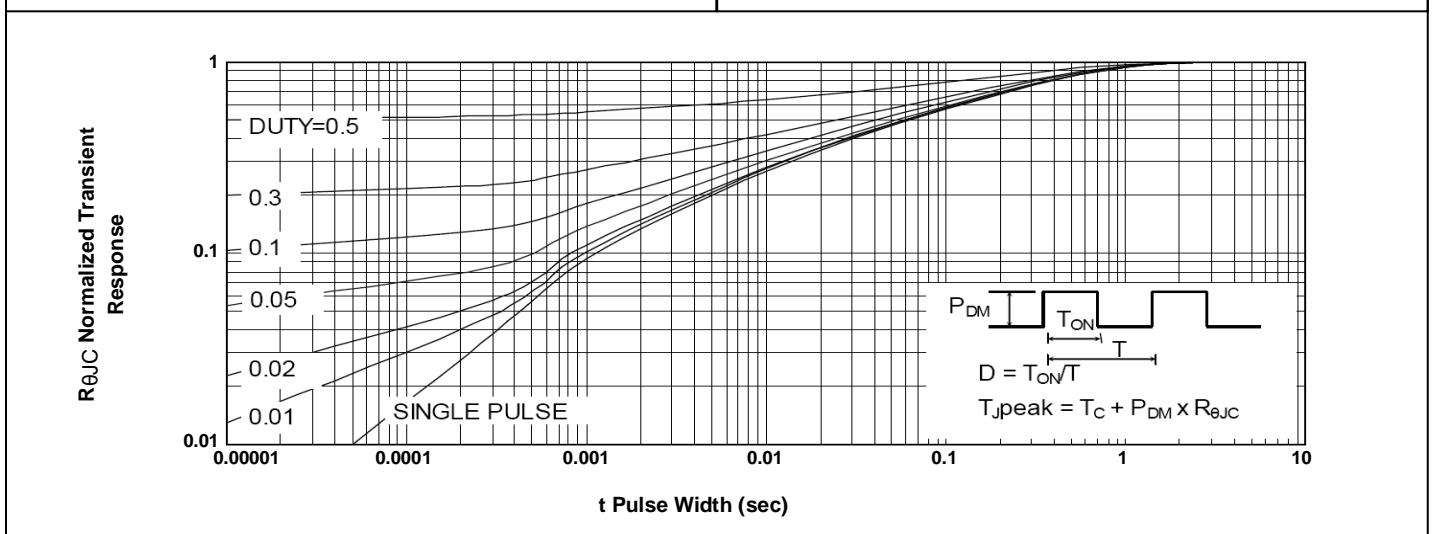


FIG.11-Normalized Maximum Transient Thermal Impedance

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